

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

2SA2124-

PNP Epitaxial Planar Silicon Transistor

High-Current Switching Applications

Applications

· Voltage regulators, relay drivers, lamp drivers, electrical equipment.

Features

- · Adoption of MBIT processes.
- · Low collector-to-emitter saturation voltage.
- · High current capacity.
- · High-speed switching.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		-30	V
Collector-to-Emitter Voltage	VCEO		-30	V
Emitter-to-Base Voltage	VEBO		-6	V
Collector Current	IC		-2	А
Collector Current (Pulse)	ICP		-5	А
Base Current	IB		-400	mA
Collector Dissipation	PC	Mounted on a ceramic board (450mm ² X0.8m)	1.3	W
		Tc=25°C	3.5	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Marking: AX

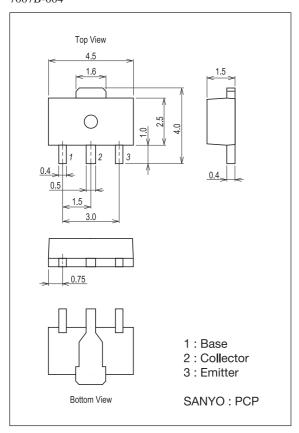
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Electrical Characteristics at Ta=25°C

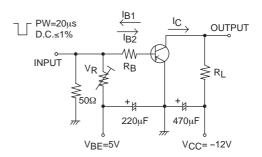
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Collector Cutoff Current	ICBO	VCB=-30V, IE=0A			-0.1	μА
Emitter Cutoff Current	IEBO	V _{EB} =-4V, I _C =0A			-0.1	μΑ
DC Current Gain	hFE(1)	V _{CE} =-2V, I _C =-100mA	200		560	
	hFE(2)	VCE=-2V, IC=-1.5A	65			
Gain-Bandwidth Product	fT	V _{CE} =-10V, I _C =-300mA		440		MHz
Collector-to-Emitter Saturation Voltage	VCE(sat)	I _C =-1.5A, I _B =-75mA		-0.2	-0.4	V
Base-to-Emitterr Saturation Voltage	V _{BE} (sat)	I _C =-1.5V, I _B =-75mA		-0.95	-1.2	V
Collector-to-Base Breakdown Voltage	V(BR)CBO	I _C =-10μA, I _E =0A	-30			V
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC=-1mA, RBE=∞	-30			V
Emitter-to-Base Breakdown Voltage	V(BR)EBO	I _E =-10μA, I _C =0A	-6			V
Output Capacitance	Cob	V _{CB} =-10V, f=1MHz		17		pF
Turn-On Time	ton	See specified Test Circuit.		45		ns
Storage Time	t _{stg}	See specified Test Circuit.		200		ns
Fall Time	tf	See specified Test Circuit.		23		ns

Package Dimensions

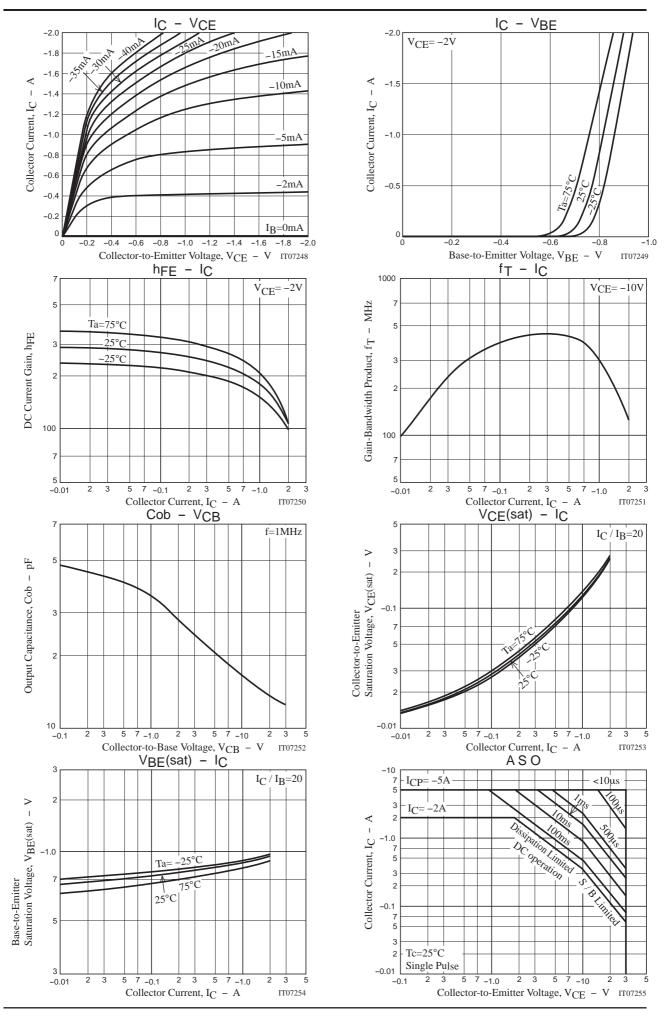
unit : mm (typ) 7007B-004

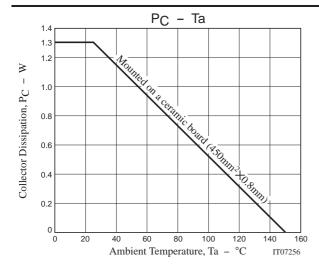


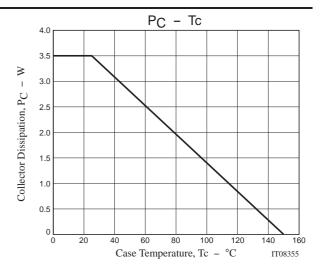
Switching Time Test Circuit



$$I_{C} = -20I_{B1} = 20I_{B2} = -0.5A$$







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